

**/ Descriptions**

SOT-23          PNP                          Silicon PNP transistor in a SOT-23 Plastic Package.

**/ Features**

Low current ,Low voltage ,S-mini package, HF Product.

**/ Applications**

General power amplifier application.

**/ Equivalent Circuit**



PIN1 Base          PIN 2 Emitter                          PIN 3 Collector

**/ h<sub>FE</sub> Classifications & Marking**

h <sub>FE</sub> Classifications Symbol	A	B
h <sub>FE</sub> Range	125 250	220 475
Marking	G3A	G3B

**/ Absolute Maximum Ratings(Ta=25 )**

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	$V_{CBO}$	-80	V
Collector to Emitter Voltage	$V_{CEO}$	-65	V
Emitter to Base Voltage	$V_{EBO}$	-5.0	V
Collector Current	$I_C$	-100	mA
Collector Power Dissipation	$P_C$	350	mW
Junction Temperature	T	150	
Storage Temperature Range	$T_{stg}$	-55 150	

**/ Electrical Characteristics(Ta=25 )**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	$I_{CBO}$	$V_{CB}=-30V$ $I_E=0$			-0.015	$\mu A$
DC Current Gain	$h_{FE}$	$V_{CE}=-5.0V$ $I_C=-2.0mA$	125		475	
Collector-Emitter Saturation Voltage	$V_{CE(sat) (1)}$	$I_C=-10mA$ $I_B=-0.5mA$		-0.09	-0.3	V
	$V_{CE(sat) (2)}$	$I_C=-100mA$ $I_B=-5.0mA$		-0.25	-0.65	V
Base-Emitter Saturation Voltage	$V_{BE(sat) (1)}$	$I_C=-10mA$ $I_B=-0.5mA$		-0.7		V
	$V_{BE(sat) (2)}$	$I_C=-100mA$ $I_B=-5.0mA$		-0.9		V
Base-Emitter Voltage	$V_{BE(ON)1}$	$V_{CE}=-5.0V$ $I_C=-2.0mA$	-0.6	-0.65	-0.75	V
	$V_{BE(ON)2}$	$V_{CE}=-5.0V$ $I_C=-10mA$			-0.82	V
Transition Frequency	$f_T$	$V_{CE}=-5.0V$ $f=100MHz$ $I_E=10mA$		150		MHz
Collector Output Capacitance	$C_{ob}$	$V_{CB}=-10V$ $f=1MHz$ $I_E=0$		4.5		pF
Noise Figure	NF	$V_{CE}=-6.0V$ $I_C=-0.2mA$ $R_g=2K$ $f=1KHz$		2.0	10	dB

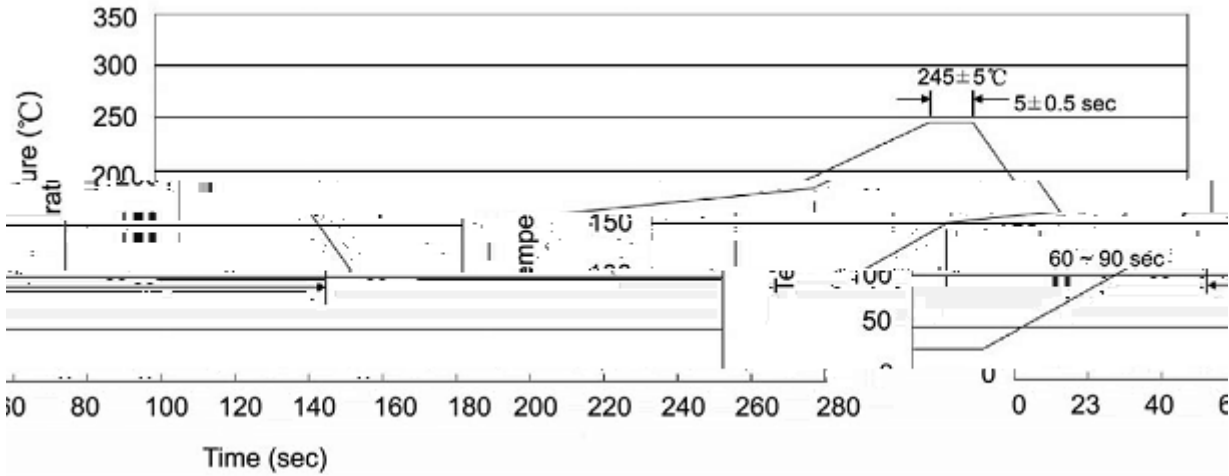
/ Electrical Characteristic Curve







( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- |   |       |     |       |          |   |
|---|-------|-----|-------|----------|---|
| 1 | 25    | 150 | 60    | 90sec;   | 1.Preheating:25~150 , Time:60~90sec.    |
| 2 | 245±5 |     | 5±0.5 | sec;     | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 |       |     | 2     | 10 /sec. | 3. Cooling Speed: 2~10 /sec.            |

/ Resistance to Soldering Heat Test Conditions

260±5                      10±1 sec.                      Temp.:260±5                      Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm <sup>3</sup> )		

/ Notices